

Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

Series/Type: B32674 ... B32678

Date: August 2019

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Metallized polypropylene film capacitors (MKP)

B32674 ... B32678

MKP DC link – high power series

Typical applications

- Frequency converters
- Industrial and high-end power supplies
- Solar inverters

Climatic

- Max. operating temperature: 105 °C (case)
- Climatic category (IEC 60068-1:2013): 40/105/56

Construction

- Dielectric: Polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Capacitance value up to 270 μF
- High CV product, compact
- Good self-healing properties
- Over-voltage capability
- Low losses with high current capability
- High reliability
- Long useful life
- AEC-Q200D compliant

Terminals

- Parallel wire leads, lead-free tinned
- 2-pin, 4-pin and 12-pin versions
- Standard lead lengths: 6 –1 mm

Marking

Manufacturer's logo and lot number, date code, rated capacitance (coded), capacitance tolerance (code letter), rated DC voltage

Delivery mode

Bulk (untaped, lead length 6-1 mm)







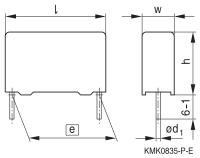
Dimensional drawings

Dimensions in mm

Number of wires	Lead spacing e ±0.4	Lead diameter d ₁ ±0.05	Туре
2-pin	27.5	0.8	B32674D
2-pin	37.5	1.0	B32676T
4-pin	37.5	1.2	B32676G
4-pin	37.5	1.2	B32676T
4-pin	52.5	1.2	B32678G
4-pin	52.5	1.2	B32678T
12-pin	52.5	1.2	B32678J

Dimensional drawings 2-pin versions

B32674D

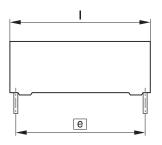


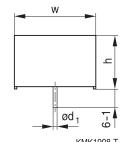
Lead spacing e ±0.4:	27.5
Lead diameter d₁:	0.8

(Dimensions in mm)



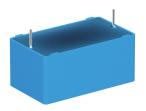
B32676T (low profile)





	KIVIK 1908-1
Lead spacing @ ±0.4:	37.5
Lead diameter d ₁ :	1.0

(Dimensions in mm)



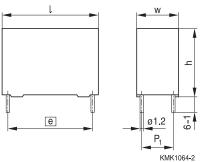




MKP DC link - high power series

Dimensional drawings 4-pin versions

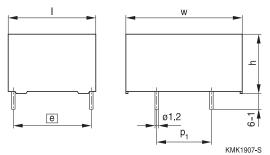
B32676G, B32678G



	B32676G	B32678G
Lead spacing e ±0.4:	37.5	52.5
Lead diameter d₁:	1.2	1.2

(Dimensions in mm)

B32676T, **B32678T** (low profile)

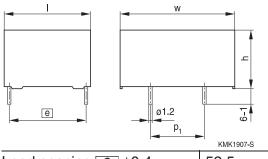


	B32676T	B32678T
Lead spacing e ±0.4:	37.5	52.5
Lead diameter d₁:	1.2	1.2

(Dimensions in mm)

Dimensional drawing 12-pin version

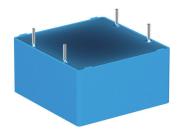
B32678J



Lead spacing e ±0.4:	52.5
Lead diameter d₁:	1.2

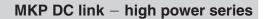
(Dimensions in mm)













Overview of available types

Lead spacing	27.5 m	ım				37.5 m	m			
Туре	B3267					B32676				
Page	7 9									
V _R (V DC)	300	450	630	750	875	300	450	630	750	875
C _R (μF)										
0.47										
0.68										
1.0										
1.5										
2.0										
2.2										
2.7										
3.0										
3.3										
3.5										
4.0										
4.7										
5.0										
5.6										
6.0										
6.2										
6.8										
7.5										
8.0										
8.2										
9.0										
10										
12										
13										
14										
15										
20										
22										
25										
30										
35										



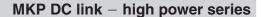


MKP DC link - high power series

Overview of available types

Lead spacing	52.5 mm				
Туре	B32678				
Page	11				
V _R (V DC)	300	450	630	750	875
C _R (μF)					
7.0					
9.0					
13					
15					
20					
22					
24					
25					
28					
30					
35					
38					
40					
45					
47					
60					
65					
80					
85					
100					
120					
180					
270					







Ordering codes and packing units (lead spacing 27.5 mm)

$C_R^{1)}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} ³⁾	$tan \delta$	tan δ	pcs./
	$w \times h \times l$		(composition see	70 °C	70 °C				MOQ
			below)	10 kHz	10 kHz		1 kHz	10 kHz	
μF	mm	mm		Α	mΩ	nH	10 ⁻³	10 ⁻³	
V _{R,85} °($_{\rm C} = 300 \text{ V DC}, V_{\rm op,70}$	_C =	450 V DC						
2.2	$11.0 \times 19.0 \times 31.5$	_	B32674D3225+000	5.0	18.1	16.0	0.7	4.1	1280
3.3	$12.5 \times 21.5 \times 31.5$	_	B32674D3335+000	7.0	12.2	19.0	0.7	4.1	1120
4.7	$14.0\times24.5\times31.5$	_	B32674D3475+000	8.5	8.9	21.0	0.7	4.2	1040
5.0	$15.0 \times 24.5 \times 31.5$	_	B32674D3505+000	9.0	8.4	21.0	0.7	4.2	960
6.8	$18.0 \times 27.5 \times 31.5$	_	B32674D3685+000	11.5	6.3	24.0	0.7	4.4	800
8.0	$16.0 \times 32.0 \times 31.5$	_	B32674D3805+000	12.5	5.6	27.0	0.7	4.5	880
8.2	$18.0 \times 33.0 \times 31.5$	_	B32674D3825+000	13.0	5.5	27.0	0.7	4.5	800
10.0	$21.0 \times 31.0 \times 31.5$	_	B32674D3106+000	14.5	4.6	27.0	0.8	4.6	720
12.0	$22.0 \times 36.5 \times 31.5$	_	B32674D3126+000	17.0	4.0	31.0	0.8	4.9	640
V _{R,85} °($_{\rm C} = 450 \text{ V DC}, V_{\rm op,70}$	_C =	630 V DC						
1.5	$11.0 \times 19.0 \times 31.5$	_	B32674D4155+000	4.5	22.1	16.0	0.6	3.3	1280
2.2	$12.5 \times 21.5 \times 31.5$	-	B32674D4225+000	6.0	14.9	19.0	0.6	3.3	1120
3.3	$15.0 \times 24.5 \times 31.5$	_	B32674D4335+000	8.0	10.3	22.0	0.6	3.4	960
4.7	$18.0 \times 27.5 \times 31.5$	-	B32674D4475+000	10.5	7.5	24.0	0.6	3.5	800
5.0	$16.0 \times 32.0 \times 31.5$	-	B32674D4505+000	11.0	7.1	28.0	0.7	3.6	880
5.6	$18.0 \times 33.0 \times 31.5$	-	B32674D4565+000	12.0	6.3	29.0	0.7	3.6	800
6.0	$21.0 \times 31.0 \times 31.5$	-	B32674D4605+000	13.0	5.9	28.0	0.7	3.6	720
6.8	$22.0 \times 36.5 \times 31.5$	-	B32674D4685+000	14.5	5.4	29.0	0.7	3.7	640
7.5	$22.0\times36.5\times31.5$	_	B32674D4755+000	15.0	5.0	32.0	0.7	3.8	640
V _{R,85} °($_{\rm C} = 630 \text{ V DC}, V_{\rm op,70}$	_C =	800 V DC						
1.0	$11.0 \times 19.0 \times 31.5$	_	B32674D6105+000	4.0	26.1	17.0	0.6	2.7	1280
1.5	$12.5 \times 21.5 \times 31.5$	_	B32674D6155+000	5.5	17.9	19.0	0.6	2.7	1120
2.2	$15.0 \times 24.5 \times 31.5$	_	B32674D6225+000	7.5	12.4	21.0	0.6	2.7	960
3.3	$16.0 \times 32.0 \times 31.5$	_	B32674D6335+000	10.0	8.5	28.0	0.6	2.8	880
4.7	$22.0 \times 36.5 \times 31.5$	_	B32674D6475+000	13.5	6.0	31.0	0.6	3.0	640
5.0	$22.0\times36.5\times31.5$	_	B32674D6505+000	14.5	5.8	31.0	0.6	3.0	640

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$ $J = \pm 5\%$

¹⁾ Capacitance value measured at 1 kHz

²⁾ Max. ripple current I_{RMS} at 70 °C at 10 kHz for a $\Delta T \le$ 20 °C when $\Delta ESR_{typ} \le \pm 5\%$

³⁾ ESL value measured at resonance frequency (see specific graphs of Z versus frequency)





MKP DC link - high power series

Ordering codes and packing units (lead spacing 27.5 mm)

$C_R^{4)}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} 5)	ESR _{typ}	ESL _{typ} ⁶⁾	tan δ	tan δ	pcs./
	$w \times h \times l$		(composition see	70 °C	70 °C				MOQ
			below)	10 kHz	10 kHz		1 kHz	10 kHz	
μF	mm	mm		Α	mΩ	nH	10 ⁻³	10 ⁻³	
V _{R,85} °($_{\rm C} = 750 \text{ V DC}, V_{\rm op,70}$	_C =	900 V DC						
0.68	$11.0 \times 19.0 \times 31.5$	-	B32674D1684+000	3.5	34.7	17.0	0.5	2.4	1280
1.0	$12.5 \times 21.5 \times 31.5$	_	B32674D1105+000	4.5	24.2	18.0	0.5	2.5	1120
1.5	$14.0 \times 24.5 \times 31.5$	_	B32674D1155+000	6.5	16.3	22.0	0.6	2.5	1040
2.2	$18.0 \times 27.5 \times 31.5$	_	B32674D1225+000	8.5	11.3	24.0	0.6	2.5	800
3.3	$21.0 \times 31.0 \times 31.5$	_	B32674D1335+000	11.0	7.9	28.0	0.6	2.6	720
4.0	$22.0 \times 36.5 \times 31.5$	_	B32674D1405+000	13.0	6.7	32.0	0.6	2.7	640
V _{R,85} °($_{\rm C} = 875 \text{ V DC}, V_{\rm op,70}$	_C = 1	050 V DC						
0.47	$11.0 \times 19.0 \times 31.5$	_	B32674D8474+000	3.0	45.2	16.0	0.5	2.2	1280
0.68	$11.0 \times 21.0 \times 31.5$	_	B32674D8684+000	4.0	31.5	19.0	0.5	2.2	1280
1.0	$13.5 \times 23.0 \times 31.5$	_	B32674D8105+000	5.0	22.2	20.0	0.5	2.2	1040
1.5	$18.0 \times 27.5 \times 31.5$	_	B32674D8155+000	7.5	14.7	23.0	0.5	2.2	800
2.2	$18.0 \times 33.0 \times 31.5$	_	B32674D8225+000	9.5	10.3	29.0	0.5	2.3	800
3.0	$22.0 \times 36.5 \times 31.5$	_	B32674D8305+000	12.0	7.8	31.0	0.5	2.4	640

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$

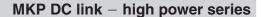
 $J = \pm 5\%$

⁴⁾ Capacitance value measured at 1 kHz

⁵⁾ Max. ripple current I_{RMS} at 70 °C at 10 kHz for a $\Delta T \le 20$ °C when $\Delta ESR_{typ} \le \pm 5\%$

⁶⁾ ESL value measured at resonance frequency (see specific graphs of Z versus frequency)







Ordering codes and packing units (lead spacing 37.5 mm)

$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	$C_R^{1)}$	Max. dimensions	P_1	Ordering code	I _{RMS,max} ²⁾	ESR_{typ}	ESL _{typ} ³⁾	tan δ	tan δ	pcs./
		$w \times h \times I$		(composition see	70 °C	70 °C				MOQ
V _{R,85°C} = 300 V DC, V _{op,70°C} = 450 V DC 6.2 24.0 × 15.0 × 41.5				below)	10 kHz	10 kHz		1 kHz	10 kHz	
6.2 24.0 × 15.0 × 41.5 − B32676T3625+000 8.0 12.6 18.0 1.1 8.2 1040 9.0 24.0 × 19.0 × 41.5 − B32676T3905+000 10.0 9.1 19.0 1.1 8.3 780 15.0 20.0 × 39.5 × 42.0 10.2 B32676G3156+000 16.0 5.4 10.0 1.1 8.3 640 20.0 28.0 × 37.0 × 42.0 10.2 B32676G3156+000 20.0 4.0 11.0 1.1 8.4 440 20.0 43.0 × 22.0 × 41.5 20.3 B32676T3206K000 19.5 4.0 13.0 1.1 8.3 280 22.0 28.0 × 42.5 × 42.0 10.2 B32676G3226+000 21.5 3.8 11.0 1.2 8.5 440 25.0 28.0 × 42.5 × 42.0 10.2 B32676G3256+000 22.5 3.4 12.0 1.2 8.6 440 30.0 30.0 × 45.0 × 42.0 20.3 B32676G3306+000 29.5 2.5 13.0 1.2 8.8 180 1.3 2.5	μF	mm	mm		Α	$m\Omega$	nH	10 ⁻³	10 ⁻³	
9.0 24.0 × 19.0 × 41.5 — B32676T3905+000 10.0 9.1 19.0 1.1 8.3 780 15.0 20.0 × 39.5 × 42.0 10.2 B32676G3156+000 20.0 4.0 11.0 1.1 8.4 440 20.0 43.0 × 22.0 × 41.5 20.3 B32676G3226+000 21.5 3.8 11.0 1.2 8.5 440 25.0 28.0 × 42.5 × 42.0 10.2 B32676G3256+000 22.5 3.4 12.0 1.2 8.6 440 30.0 30.0 × 45.0 × 42.0 20.3 B32676G33266+000 25.5 3.4 12.0 1.2 8.7 400 35.0 33.0 × 48.0 × 42.0 20.3 B32676G3356+000 25.5 3.4 12.0 1.2 8.8 180 1.2 8.5 440 4.0 24.0 × 15.0 × 41.5 — B32676G3356+000 25.5 3.4 12.0 1.2 8.8 180 1.2 8.5 440 4.0 24.0 × 15.0 × 41.5 — B32676G3366+000 25.5 3.4 12.0 1.2 8.8 180 1.0 6.6 780 4.0 24.0 × 15.0 × 41.5 — B32676T4405+000 7.0 15.5 19.0 1.0 6.6 780	$V_{R,85}$	° _C = 300 V DC, V _{op,70}) °C =	450 V DC						
15.0 20.0 × 39.5 × 42.0 10.2 B32676G3156+000 16.0 5.4 10.0 1.1 8.3 640 20.0 28.0 × 37.0 × 42.0 10.2 B32676G3206+000 20.0 4.0 11.0 1.1 8.4 440 20.0 43.0 × 22.0 × 41.5 20.3 B32676G3206+000 21.5 3.8 11.0 1.2 8.5 440 25.0 28.0 × 42.5 × 42.0 10.2 B32676G3256+000 21.5 3.8 11.0 1.2 8.5 440 45.0 24.5 × 42.0 10.2 B32676G3256+000 22.5 3.4 12.0 1.2 8.6 440 45.0 30.0 30.0 × 45.0 × 42.0 20.3 B32676G3306+000 26.0 2.8 12.0 1.2 8.7 400 35.0 33.0 × 48.0 × 42.0 20.3 B32676G3356+000 29.5 2.5 13.0 1.2 8.8 180 V _{R,85} c = 450 V DC, V _{9p,70} c = 630 V DC 4.0 24.0 × 15.0 × 41.5 — B32676G4825+000 31.5 7.8 9.0 1.0 6.6 780 7	6.2	$24.0 \times 15.0 \times 41.5$	_	B32676T3625+000	8.0	12.6	18.0	1.1	8.2	1040
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	9.0	$24.0 \times 19.0 \times 41.5$	_	B32676T3905+000	10.0	9.1	19.0	1.1	8.3	780
20.0	15.0	$20.0 \times 39.5 \times 42.0$	10.2	B32676G3156+000	16.0	5.4	10.0	1.1	8.3	640
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	20.0	$28.0 \times 37.0 \times 42.0$	10.2	B32676G3206+000	20.0	4.0	11.0	1.1	8.4	440
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	20.0	$43.0 \times 22.0 \times 41.5$	20.3	B32676T3206K000	19.5	4.0	13.0	1.1	8.3	280
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	22.0	$28.0 \times 42.5 \times 42.0$	10.2	B32676G3226+000	21.5	3.8	11.0	1.2	8.5	440
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	25.0	$28.0 \times 42.5 \times 42.0$	10.2	B32676G3256+000	22.5	3.4	12.0	1.2	8.6	440
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	30.0	$30.0 \times 45.0 \times 42.0$	20.3	B32676G3306+000	26.0	2.8	12.0	1.2	8.7	400
4.0 24.0 × 15.0 × 41.5 — B32676T4405+000 7.0 15.5 19.0 1.0 6.6 1040 4.7 24.0 × 19.0 × 41.5 — B32676T4475+000 8.0 13.2 18.0 1.0 6.6 780 8.2 20.0 × 39.5 × 42.0 10.2 B32676G4106+000 14.5 6.4 11.0 1.0 6.7 640 13.0 43.0 × 22.0 × 41.5 20.3 B32676G4136+000 17.5 5.0 13.0 1.0 6.6 280 15.0 28.0 × 42.5 × 42.0 10.2 B32676G4156+000 20.0 4.4 11.0 1.0 6.8 440 20.0 30.0 × 45.0 × 42.0 20.3 B32676G4206K000 24.0 3.3 13.0 1.0 6.9 400 25.0 33.0 × 48.0 × 42.0 20.3 B32676G4256K000 28.0 2.8 14.0 1.0 7.1 180 V _{R,85} ° _C = 630 V DC, V _{op,70} ° _C = 800 V DC 800 V DC 8.0 14.1 19.0 0.8 5.1 1040 3.5 24.0 × 19.0 × 41.5 — B32676T6275+000 7.0	35.0	$33.0\times48.0\times42.0$	20.3	B32676G3356+000	29.5	2.5	13.0	1.2	8.8	180
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$V_{R,85}$	$_{^{\circ}C}$ = 450 V DC, $V_{op,70}$	o °C =	630 V DC						
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	4.0	$24.0\times15.0\times41.5$	_	B32676T4405+000	7.0	15.5	19.0	1.0	6.6	1040
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	4.7	$24.0 \times 19.0 \times 41.5$	_	B32676T4475+000	8.0	13.2	18.0	1.0	6.6	780
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	8.2	$20.0 \times 39.5 \times 42.0$	10.2	B32676G4825+000	13.5	7.8	9.0	1.0	6.7	640
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	10.0	$20.0\times39.5\times42.0$	10.2	B32676G4106+000	14.5	6.4	11.0	1.0	6.7	640
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	13.0	$43.0 \times 22.0 \times 41.5$	20.3	B32676T4136K000	17.5	5.0	13.0	1.0	6.6	280
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	15.0	$28.0\times42.5\times42.0$	10.2	B32676G4156+000	20.0	4.4	11.0	1.0	6.8	440
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	20.0	$30.0\times45.0\times42.0$	20.3	B32676G4206K000	24.0	3.3	13.0	1.0	6.9	400
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	25.0	$33.0\times48.0\times42.0$	20.3	B32676G4256K000	28.0	2.8	14.0	1.0	7.1	180
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$V_{R,85}$	$_{\rm C}$ = 630 V DC, $V_{\rm op,70}$	o °C =	800 V DC						
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	2.7	$24.0\times15.0\times41.5$	_	B32676T6275+000	7.0	17.7	20.0	8.0	5.1	1040
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	3.5	$24.0 \times 19.0 \times 41.5$	_	B32676T6355+000	8.0	14.1	19.0	0.8	5.1	780
8.2 28.0 × 37.0 × 42.0 10.2 B32676G6825+000 16.0 6.1 11.0 0.8 5.2 440 9.0 43.0 × 22.0 × 41.5 20.3 B32676T6905K000 16.5 5.7 13.0 0.8 5.1 280 10.0 28.0 × 42.5 × 42.0 10.2 B32676G6106+000 18.5 5.1 11.0 0.8 5.2 440 12.0 28.0 × 42.5 × 42.0 10.2 B32676G6126+000 20.0 4.4 12.0 0.8 5.3 440 14.0 30.0 × 45.0 × 42.0 20.3 B32676G6146+000 23.0 3.7 14.0 0.8 5.3 400	6.8	$20.0\times39.5\times42.0$	10.2	B32676G6685+000	13.5	7.4	10.0	0.8	5.2	640
9.0 43.0 × 22.0 × 41.5 20.3 B32676T6905K000 16.5 5.7 13.0 0.8 5.1 280 10.0 28.0 × 42.5 × 42.0 10.2 B32676G6106+000 18.5 5.1 11.0 0.8 5.2 440 12.0 28.0 × 42.5 × 42.0 10.2 B32676G6126+000 20.0 4.4 12.0 0.8 5.3 440 14.0 30.0 × 45.0 × 42.0 20.3 B32676G6146+000 23.0 3.7 14.0 0.8 5.3 400	7.5	$20.0\times39.5\times42.0$	10.2	B32676G6755+000	14.5	6.6	12.0	0.8	5.2	640
10.0 28.0 × 42.5 × 42.0 10.2 B32676G6106+000 18.5 5.1 11.0 0.8 5.2 440 12.0 28.0 × 42.5 × 42.0 10.2 B32676G6126+000 20.0 4.4 12.0 0.8 5.3 440 14.0 30.0 × 45.0 × 42.0 20.3 B32676G6146+000 23.0 3.7 14.0 0.8 5.3 400	8.2	$28.0 \times 37.0 \times 42.0$	10.2	B32676G6825+000	16.0	6.1	11.0	0.8	5.2	440
12.0 28.0 × 42.5 × 42.0 10.2 B32676G6126+000 20.0 4.4 12.0 0.8 5.3 440 14.0 30.0 × 45.0 × 42.0 20.3 B32676G6146+000 23.0 3.7 14.0 0.8 5.3 400	9.0	$43.0\times22.0\times41.5$	20.3	B32676T6905K000	16.5	5.7	13.0	0.8	5.1	280
14.0 30.0 × 45.0 × 42.0 20.3 B32676G6146+000 23.0 3.7 14.0 0.8 5.3 400	10.0	$28.0\times42.5\times42.0$	10.2	B32676G6106+000	18.5	5.1	11.0	0.8	5.2	440
	12.0	$28.0 \times 42.5 \times 42.0$	10.2	B32676G6126+000	20.0	4.4	12.0	8.0	5.3	440
15.0 33.0 × 48.0 × 42.0 20.3 B32676G6156+000 25.0 3.5 14.0 0.8 5.4 180	14.0	$30.0 \times 45.0 \times 42.0$	20.3	B32676G6146+000	23.0	3.7	14.0	0.8	5.3	400
	15.0	$33.0 \times 48.0 \times 42.0$	20.3	B32676G6156+000	25.0	3.5	14.0	0.8	5.4	180

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$ $J = \pm 5\%$

- 1) Capacitance value measured at 1 kHz
- 2) Max. ripple current I_{RMS} at 70 °C at 10 kHz for a $\Delta T \le \!\! 20$ °C when $\Delta ESR_{typ} \le \! \pm \!\! 5\%$
- 3) ESL value measured at resonance frequency (see specific graphs of Z versus frequency)





MKP DC link - high power series

Ordering codes and packing units (lead spacing 37.5 mm)

$C_R^{4)}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} ⁵⁾	ESR _{typ}	ESL _{typ} ⁶⁾	tan δ	tan δ	pcs./
	$w \times h \times l$		(composition see	70 °C	70 °C				MOQ
			below)	10 kHz	10 kHz		1 kHz	10 kHz	
μF	mm	mm		Α	mΩ	nH	10 ⁻³	10 ⁻³	
$V_{R,85}$	°C = 750 V DC, V _{op,70}	o °C =	900 V DC						
2.0	$24.0 \times 15.0 \times 41.5$	_	B32676T1205+000	6.0	22.7	18.0	8.0	4.6	1040
2.7	$24.0 \times 19.0 \times 41.5$	_	B32676T1275+000	7.5	16.7	19.0	8.0	4.6	780
4.7	$20.0 \times 39.5 \times 42.0$	10.2	B32676G1475+000	12.0	9.5	10.0	0.8	4.6	640
5.6	$20.0 \times 39.5 \times 42.0$	10.2	B32676G1565+000	13.0	8.2	11.0	0.8	4.7	640
6.8	$28.0 \times 37.0 \times 42.0$	10.2	B32676G1685+000	15.5	6.7	11.0	0.8	4.7	440
9.0	$30.0 \times 45.0 \times 42.0$	20.3	B32676G1905+000	19.5	5.1	12.0	0.8	4.7	440
10.0	$30.0 \times 45.0 \times 42.0$	20.3	B32676G1106+000	20.5	4.7	13.0	0.8	4.8	400
12.0	$33.0 \times 48.0 \times 42.0$	20.3	B32676G1126+000	23.0	4.0	14.0	0.8	4.8	180
$V_{R,85}$	°C = 875 V DC, V _{op,70}	o °c = 1	050 V DC						
1.5	$24.0 \times 15.0 \times 41.5$	_	B32676T8155+000	5.5	26.2	18.0	0.7	4.1	1040
2.0	$24.0 \times 19.0 \times 41.5$	_	B32676T8205+000	7.0	19.6	19.0	0.7	4.1	780
3.3	$20.0 \times 39.5 \times 42.0$	10.2	B32676G8335+000	10.5	12.0	9.0	0.7	4.1	640
4.0	$20.0 \times 39.5 \times 42.0$	10.2	B32676G8405+000	12.0	9.9	11.0	0.7	4.1	640
4.7	$28.0 \times 37.0 \times 42.0$	10.2	B32676G8475+000	13.5	8.6	10.0	0.7	4.1	440
6.8	$28.0 \times 42.5 \times 42.0$	10.2	B32676G8685+000	17.0	6.0	12.0	0.7	4.2	440
7.5	$30.0 \times 45.0 \times 42.0$	20.3	B32676G8755+000	19.0	5.4	13.0	0.7	4.2	400
10.0	$33.0\times48.0\times42.0$	20.3	B32676G8106K000	22.5	4.3	14.0	0.7	4.3	180

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$

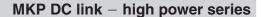
 $J = \pm 5\%$

⁴⁾ Capacitance value measured at 1 kHz

⁵⁾ Max. ripple current I_{RMS} at 70 °C at 10 kHz for a $\Delta T \le 20$ °C when $\Delta ESR_{typ} \le \pm 5\%$

⁶⁾ ESL value measured at resonance frequency (see specific graphs of Z versus frequency)







Ordering codes and packing units (lead spacing 52.5 mm)

$C_R^{1)}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} ³⁾	tan δ	$tan \ \delta$	pcs./
	$w \times h \times I$		(composition see	70 °C	70 °C				MOQ
			below)	10 kHz	10 kHz		1 kHz	10 kHz	
μF	mm	mm		Α	mΩ	nΗ	10 ⁻³	10 ⁻³	
V _{R,85} °C	$_{\rm c} = 300 \text{ V DC}, V_{\rm op,70} ^{\circ}\text{C}$; = 4	50 V DC						
30.0	$43.0 \times 24.0 \times 57.5$	20.3	B32678T3306K000	22.5	3.9	13.0	1.5	11.8	560
40.0	$30.0\times45.0\times57.5$	20.3	B32678G3406+000	28.0	3.0	12.0	1.5	12.3	280
47.0	$35.0\times50.0\times57.5$	20.3	B32678G3476+000	33.0	2.6	13.0	1.5	12.5	108
60.0	$35.0\times50.0\times57.5$	20.3	B32678G3606K000	37.0	2.1	15.0	1.6	12.9	108
80.0	$45.0\times57.0\times57.5$	20.3	B32678G3806+000	47.0	1.6	18.0	1.6	13.5	140
80.0	$130.0 \times 24.0 \times 57.5$	20.3	B32678J3806K000	51.0	1.4	4.0	1.5	11.7	80
100.0	$60.0 \times 45.0 \times 57.5$	20.3	B32678G3107+000	48.0	1.4	19.0	1.6	13.5	200
270.0	$130.0\times58.0\times57.5$	20.3	B32678J3277K000	108.0	0.5	6.0	1.6	13.8	40
V _{R,85} °C	$_{\rm c}$ = 450 V DC, $V_{\rm op,70} ^{\circ}{\rm C}$	= 6	30 V DC						
20.0	$43.0\times24.0\times57.5$	20.3	B32678T4206K000	20.0	4.9	13.0	1.3	9.8	560
30.0	$35.0\times50.0\times57.5$	20.3	B32678G4306+000	28.0	3.2	14.0	1.3	9.9	108
35.0	$35.0\times50.0\times57.5$	20.3	B32678G4356+000	31.5	2.8	14.0	1.3	10.0	108
40.0	$35.0\times50.0\times57.5$	20.3	B32678G4406K000	34.0	2.5	15.0	1.3	10.2	108
60.0	$45.0\times57.0\times57.5$	20.3	B32678G4606+000	45.0	1.8	18.0	1.4	11.2	140
60.0	$130.0 \times 24.0 \times 57.5$	20.3	B32678J4606K000	49.5	1.6	4.0	1.2	9.5	80
65.0	$60.0 \times 45.0 \times 57.5$	20.3	B32678G4656+000	48.0	1.6	19.0	1.3	10.6	200
180.0	$130.0\times58.0\times57.5$	20.3	B32678J4187K000	97.5	0.6	6.0	1.4	11.2	40
V _{R,85} °c	$_{\rm C}$ = 630 V DC, $V_{\rm op,70^{\circ}C}$	= 80	00 V DC						
13.0	$43.0\times24.0\times57.5$	20.3	B32678T6136K000	18.0	5.9	13.0	1.1	7.9	560
20.0	$35.0\times50.0\times57.5$	20.3	B32678G6206+000	26.5	4.0	13.0	1.1	8.2	108
25.0	$35.0\times50.0\times57.5$	20.3	B32678G6256+000	29.5	3.3	15.0	1.1	8.3	108
38.0	$130.0\times24.0\times57.5$	20.3	B32678J6386K000	43.5	2.1	4.0	1.1	7.9	80
40.0	$45.0\times57.0\times57.5$	20.3	B32678G6406+000	41.0	2.1	18.0	1.2	8.8	140
45.0	$60.0\times45.0\times57.5$	20.3	B32678G6456+000	43.0	1.9	19.0	1.2	8.7	200
120.0	$130.0\times58.0\times57.5$	20.3	B32678J6127K000	90.0	0.7	6.0	1.2	8.8	40

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$ $J = \pm 5\%$

¹⁾ Capacitance value measured at 1 kHz

²⁾ Max. ripple current I_{RMS} at 70 °C at 10 kHz for a $\Delta T \le$ 20 °C when $\Delta ESR_{typ} \le \pm 5\%$

³⁾ ESL value measured at resonance frequency (see specific graphs of Z versus frequency)





MKP DC link - high power series

Ordering codes and packing units (lead spacing 52.5 mm)

$C_R^{4)}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} 5)	ESR _{typ}	ESL _{typ} ⁶⁾	tan δ	tan δ	pcs./
	$w \times h \times I$		(composition see	70 °C	70 °C				MOQ
			below)	10 kHz	10 kHz		1 kHz	10 kHz	
μF	mm	mm		Α	mΩ	nH	10-3	10 ⁻³	
V _{R,85} °C	$_{\rm c} = 750 \text{ V DC}, V_{\rm op,70} ^{\circ}\text{C}$	= 90	00 V DC						
9.0	$43.0 \times 24.0 \times 57.5$	20.3	B32678T1905K000	16.5	7.2	13.0	1.0	6.8	560
15.0	$30.0 \times 45.0 \times 57.5$	20.3	B32678G1156K000	23.0	4.5	14.0	1.0	7.0	280
20.0	$35.0 \times 50.0 \times 57.5$	20.3	B32678G1206K000	28.0	3.5	15.0	1.0	7.2	108
28.0	$45.0 \times 57.0 \times 57.5$	20.3	B32678G1286+000	37.5	2.5	18.0	1.0	7.4	140
30.0	$60.0 \times 45.0 \times 57.5$	20.3	B32678G1306+000	39.5	2.4	19.0	1.0	7.3	200
30.0	$130.0 \times 24.0 \times 57.5$	20.3	B32678J1306K000	40.5	2.3	4.0	1.0	6.8	80
85.0	$130.0 \times 58.0 \times 57.5$	20.3	B32678J1856K000	82.5	0.9	6.0	1.0	7.4	40
V _{R,85} °C	$_{\rm C}$ = 875 V DC, $V_{\rm op,70} ^{\circ}{\rm C}$	= 10	50 V DC						
7.0	$43.0 \times 24.0 \times 57.5$	20.3	B32678T8705K000	15.5	8.2	13.0	0.9	6.0	560
15.0	$35.0 \times 50.0 \times 57.5$	20.3	B32678G8156K000	26.5	4.0	15.0	0.9	6.3	108
22.0	$45.0 \times 57.0 \times 57.5$	20.3	B32678G8226+000	35.0	2.9	17.0	1.0	6.5	140
22.0	$130.0 \times 24.0 \times 57.5$	20.3	B32678J8226K000	39.0	2.6	5.0	0.9	6.0	80
24.0	$60.0 \times 45.0 \times 57.5$	20.3	B32678G8246+000	38.0	2.6	19.0	0.9	6.4	200
65.0	$130.0\times58.0\times57.5$	20.3	B32678J8656K000	78.0	1.0	6.0	1.0	6.5	40

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

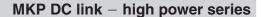
 $K = \pm 10\%$ $J = \pm 5\%$

⁴⁾ Capacitance value measured at 1 kHz

⁵⁾ Max. ripple current I_{RMS} at 70 °C at 10 kHz for a $\Delta T \le 20$ °C when $\Delta ESR_{typ} \le \pm 5\%$

⁶⁾ ESL value measured at resonance frequency (see specific graphs of Z versus frequency)





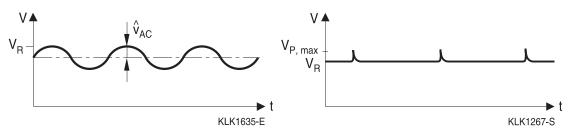


Technical data

Reference standard: IEC 61071:2007 and AEC-Q200D. All data given at $T = 20 \, ^{\circ}C$, unless otherwise specified.

wise specified.							
Rated temperature T _R		+85 °C					
Operating temperature	Max. ope	Max. operating temperature, $T_{op,max}$ +105 °C					
		Upper ca	ategory te	mperature	T _{max}	+105 °C	
		Lower ca	ategory te	mperature	T_{min}	-40 °C	
Insulation resistance F	R _{ins}	τ > 1000	0 s (after	1 min)			
given as time constan	t	For V _R ≥	500 V me	easured at	t 500 V		
$\tau = C_R \cdot R_{ins}$, rel. humi	dity ≤ 65%	For V _R <	500 V me	easured a	t V _R		
(minimum as-delivered	d values)						
DC voltage test between	en terminals (10 s)	1.5 · V _R					
Voltage test terminal t	o case (10 s)	2110 V A	AC, 50 Hz				
Pulse Handling Capab	oility (V/μs)	I _P (A) / C	(μF)				
Biased humidity		1000 ho	urs / 40 °C	C / 93% re	lative hun	nidity with V _{R,DC}	
Limit values after test		Capacitance change I∆C/CI ≤ 5%					
		Dissipation factor change $\Delta \tan \delta \le 0.002$ (at 1 kHz)					
		Insulation resistance R_{ins} $\geq 50\%$ of minimum					
					as-c	delivered values	
Reliability:	Failure rate λ	1 fit (≤ 1	· 10 ⁻⁹ /h) a	t 0.5 · V _R	, 40 °C		
	Service life t _{SL}	200 000	h at V_R , 8	5 °C			
		For conversion to other operating conditions and					
		temperat	tures, refe	r to chapt	er "Qualit	y, 2 Reliability".	
V _R (V DC)		300	450	630	750	875	
Continuous operating							
V_{op} (V DC) at 70 °C	450	630	800	900	1050		
Continuous operating							
V_{op} (V DC) at 85 $^{\circ}$ C	300	450	630	750	875		
For temperatures betw	1 2%/°C of V denating compared to V at 95 °C						
85 °C and 105 °C		1.2%/°C of V _{op} derating compared to V _{op} at 85 °C					

Typical waveforms



Restrictions:

 \mathbf{V}_{R} : Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.

 $\boldsymbol{\hat{u}_{\text{AC}}} {\leq} \boldsymbol{0.2} \, \cdot \, \boldsymbol{V_{\text{R}}}$





MKP DC link - high power series

$V_{p, max}$:

Overvoltage	Maximum duration within one day	Observation
1.1 · V _R	30% of on-load duration	System regulation
$1.15 \cdot V_R$	30 min.	System regulation
$1.2 \cdot V_R$	5 min.	System regulation
$1.3 \cdot V_R$	1 min.	System regulation

NOTE 1 An overvoltage equal to $1.5 \cdot V_R$ for 30 ms is permitted 1000 times during the life of the capacitor.

The amplitudes of the overvoltages that may be tolerated without significant reduction in the life time of the capacitor depend on their duration, the number of application and the capacitor temperature.

In addition these values assume that the overvoltages may appear when the internal temperature of the capacitor is less than 0 °C but within the temperature category.

NOTE 2 The average applied voltage must not be higher than the specified voltage.

Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/μs.

Note:

The values of dV/dt and k_0 provided below must not be exceeded in order to avoid damaging the capacitor. These parameters are given for isolated pulses in such a way that the heat generated by one pulse will be completely dissipated before applying the next pulse. For a train of pulses, please refer to the curves of permissible AC voltage-current versus frequency.

dV/dt values

Lead spacing	27.5 mm			37.5 mm				52.5 mm							
Туре	B32674			B32676				B32678							
V _R (V DC)	300	450	630	750	875	300	450	630	750	875	300	450	630	750	875
dV/dt in V/μs	40	75	100	125	150	22	54	73	85	100	15	35	50	60	70



MKP DC link – high power series



Characteristics curves

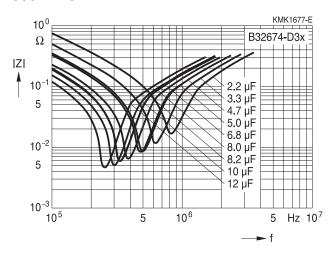
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

300 V DC

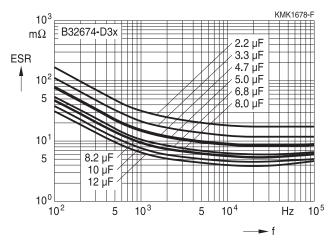


ESR versus frequency f

(typical values)

Lead spacing 27.5 mm

300 V DC

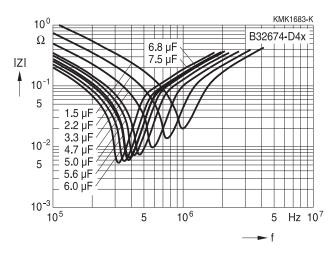


Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

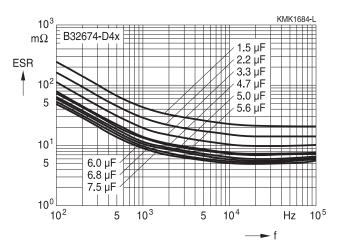
450 V DC



ESR versus frequency f

(typical values)

Lead spacing 27.5 mm







MKP DC link - high power series

Characteristics curves

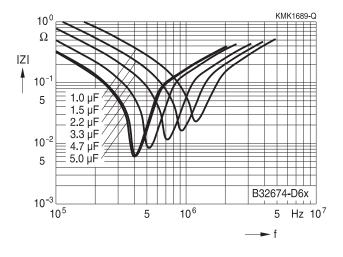
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

630 V DC

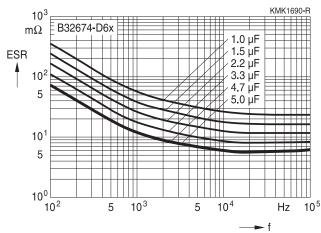


ESR versus frequency f

(typical values)

Lead spacing 27.5 mm

630 V DC

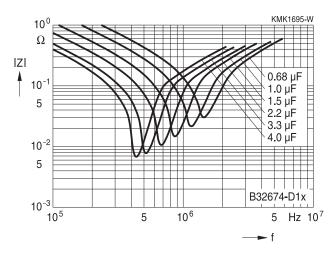


Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

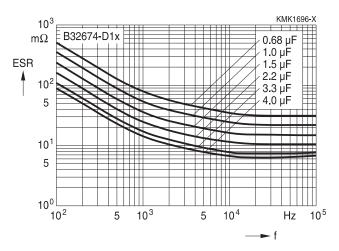
750 V DC



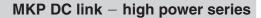
ESR versus frequency f

(typical values)

Lead spacing 27.5 mm









Characteristics curves

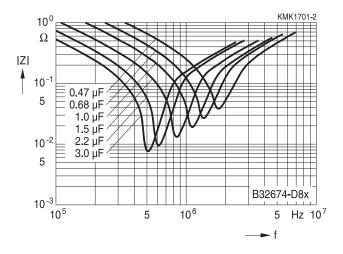
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

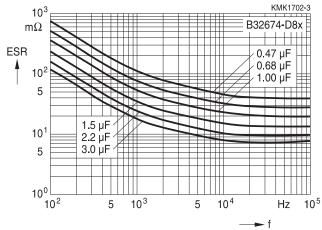
875 V DC



ESR versus frequency f

(typical values)

Lead spacing 27.5 mm







MKP DC link - high power series

Characteristics curves

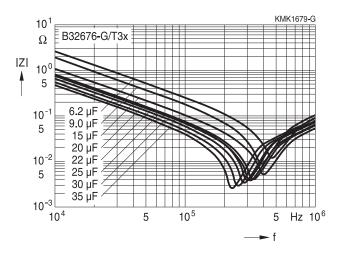
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

300 V DC

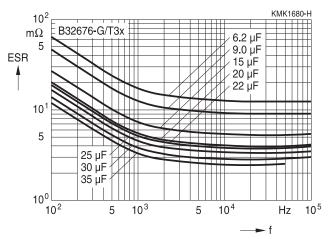


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

300 V DC

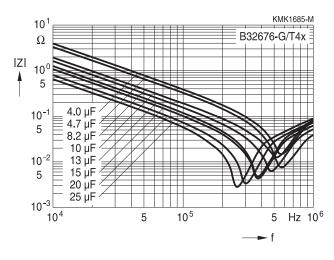


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

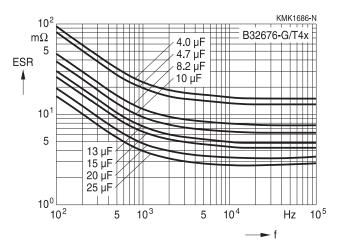
450 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm





MKP DC link – high power series



Characteristics curves

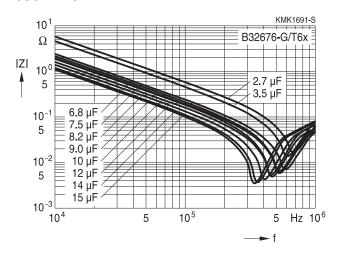
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

630 V DC

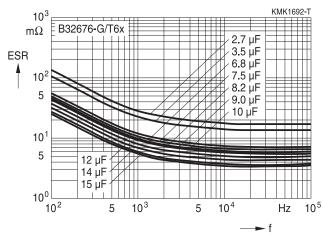


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

630 V DC

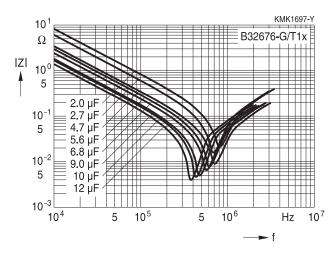


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

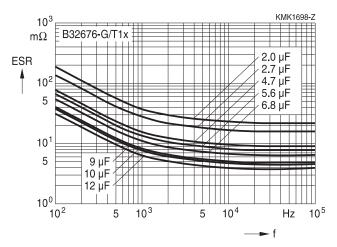
750 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm







MKP DC link - high power series

Characteristics curves

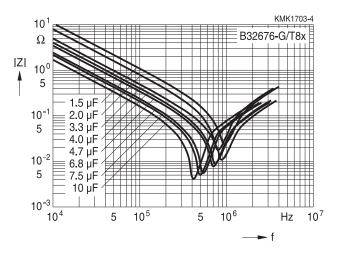
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

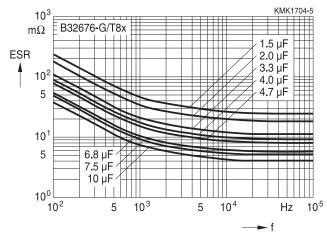
875 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm





MKP DC link – high power series



Characteristics curves

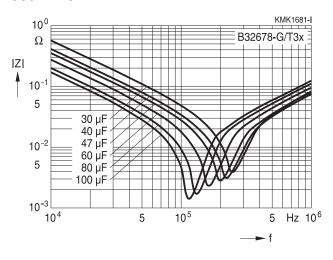
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

300 V DC

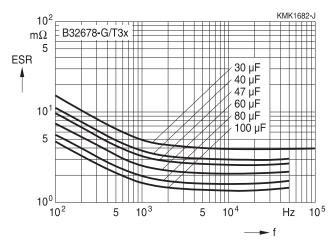


ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

300 V DC

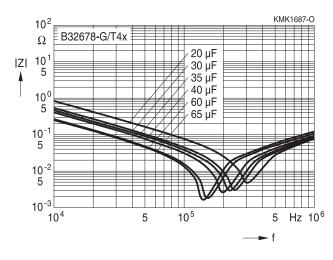


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

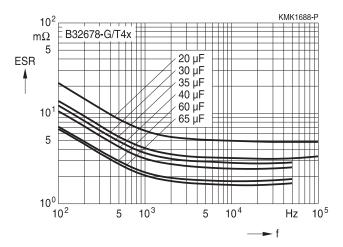
450 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm







MKP DC link – high power series

Characteristics curves

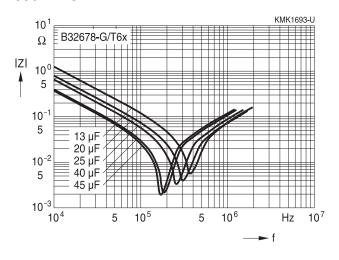
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

630 V DC

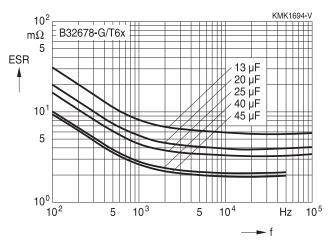


ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

630 V DC

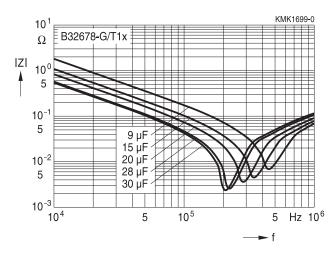


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

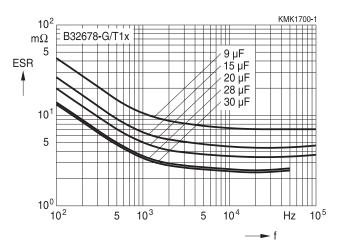
750 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm





MKP DC link – high power series



Characteristics curves

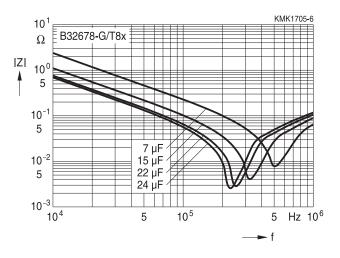
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

875 V DC

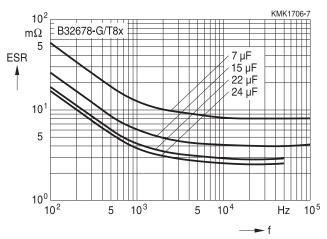


ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

875 V DC

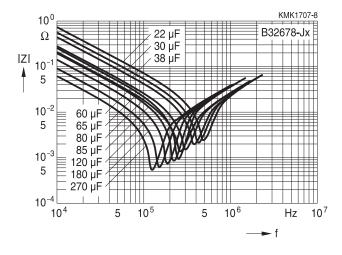


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm (12 pins)

300 V DC, 450 V DC, 630 V DC, 750 V DC, 875 V DC

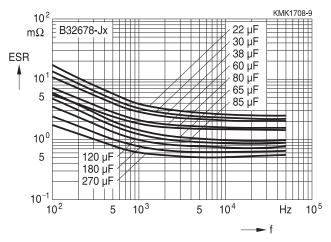


ESR versus frequency f

(typical values)

Lead spacing 52.5 mm (12 pins)

300 V DC, 450 V DC, 630 V DC, 750 V DC, 875 V DC







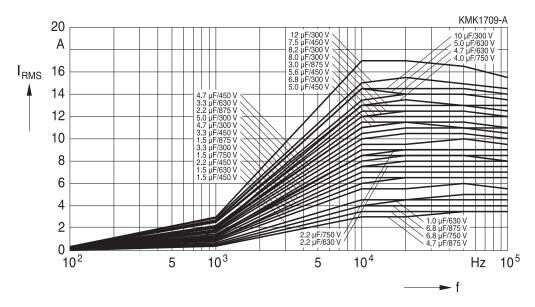
MKP DC link - high power series

Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 $^{\circ}$ C

Lead spacing 27.5 mm

B32674D*





MKP DC link – high power series

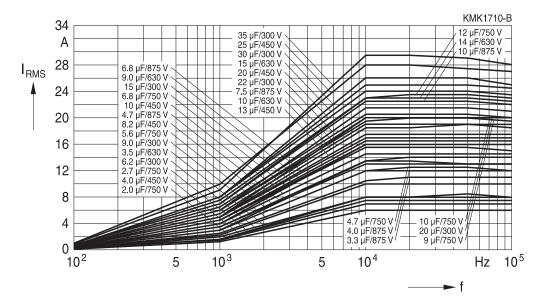


Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 37.5 mm

B32676G/T*







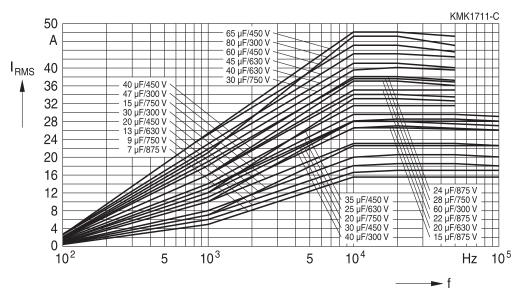
MKP DC link - high power series

Characteristics curves

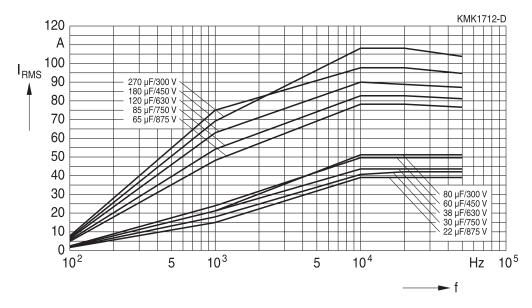
Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 52.5 mm

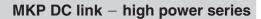
B32678G/T*



B32678J*

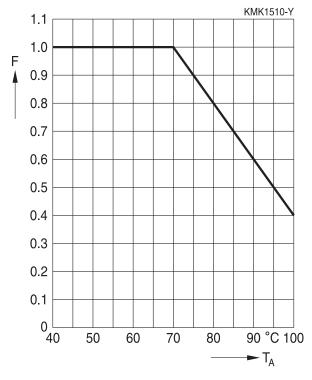








Curves characteristics (I_{RMS} derating versus temperature)



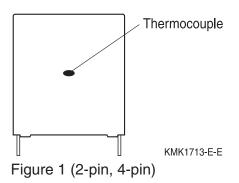
Maximum I_{RMS} current as function of the ambient temperature: I_{RMS} (T_A) = Factor \times I_{RMS} (70 °C)





MKP DC link - high power series

Heat transference for self heating calculation



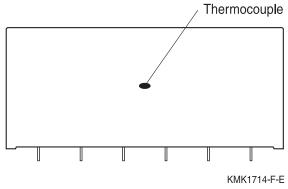


Figure 2 (12-pin)

Box dime	ensions	Equivalent heat	
		T	coefficient
w (mm)	h (mm)	I (mm)	G (mW/°C)
11.0	19.0	31.5	25
11.0	21.0	31.5	28
12.5	21.5	31.5	30
13.5	23.0	31.5	32
14.0	24.5	31.5	35
15.0	24.5	31.5	36
16.0	32.0	31.5	45
18.0	27.5	31.5	44
18.0	33.0	31.5	48
19.0	30.0	31.5	48
20.0	11.0	31.5	65
21.0	31.0	31.5	51
22.0	36.5	31.5	58
12.0	22.0	41.5	70
14.0	25.0	41.5	43
16.0	28.5	41.5	50
18.0	32.5	41.5	59
20.0	39.5	42.0	72
24.0	19.0	41.5	50
24.0	15.0	41.5	44
28.0	37.0	42.0	83
28.0	42.5	42.0	90
30.0	45.0	42.0	100
33.0	48.0	42.0	110
43.0	22.0	41.5	80
30.0	45.0	57.5	125
35.0	50.0	57.5	145
43.0	24.0	57.5	103
45.0	57.0	57.5	185
60.0	45.0	57.5	192
130.0	24.0	57.5	200
130.0	58.0	57.5	300

The equivalent heat coefficient "**G** (**mW**/**°C**)" is given for measuring the temperature on the lateral surface of the plastic box as figure 1 shows. By using a thermocouple and avoiding effect of radiation and convection the temperature measured during operation conditions should be a result of the dissipated power divided by the equivalent heat coefficient.







Self Heating by power dissipation and equivalent heat coefficient

The I_{RMS} and consequently the power dissipation must be limited during operation in order to not exceed the maximum limit of ΔT allowed for this series. ΔT_{max} given for this series is equal or lower than 20 °C at rated temperature (70 °C), for higher ambient temperatures ΔT_{max} (T) will have the same derating factor than I_{RMS} versus temperature and then an equivalent derating as per:

$$\Delta T_{\text{max}}$$
 (T) = (Factor)² × ΔT (70 °C).

For any particular I_{BMS} the ΔT may be calculated by:

$$\Delta T$$
 (°C) = P_{dis} (mW) / G(mW/°C).

Where ΔT (°C) is the difference between the temperature measured on the box (see figure 1) and the ambient temperature when capacitor is working during normal operation;

$$\Delta T$$
 (°C) = T_{op} (°C) $- T_{A}$ (°C).

It represents the increasing of temperature provoked by the I_{RMS} during operation.

G (mW/°C) is the equivalent heat coefficient described above and P_{dis} (mW) is the dissipated power defined by: P_{dis} (mW) = ESR_{tvp} (m Ω) × I_{RMS}^2 (A_{RMS}).

Example for thermal calculation:

We will take as reference B32678G8156K (15 μ F/875 V) type for thermal calculation. Considering the following load and capacitor characteristics:

 I_{RMS} : 15 A_{RMS} at 20 kHz

T_A: 85 ^oC

 $35 \times 50 \times 57.5$ box

G (mW/ºC): 145

Then we have to find the ESR_{tvp} at 20 kHz what is approximately 4.0 m Ω .

So according to P_{dis} (mW) = ESR_{tvp} (m Ω) × I_{RMS} ² (A_{RMS})

we have the following: P_{dis} (mW) = 4.0 m $\Omega \times 15 A_{RMS}^2 = 900$ mW.

And as per ΔT (°C) = P_{dis} (mW) / G (mW/°C)

we have the following: ΔT (°C) = 900 (mW) / 145 (mW/°C) = 6.2 °C.

What is below of the ΔT_{max} (85 °C) = (Factor)² × ΔT (70 °C) = (0.7)² × 20 °C = 9.8 °C.

On the other hand we may confirm that max I_{RMS} at 20 kHz at 70 °C = 26.5 A_{RMS} .

And then max I_{RMS} for 85 °C of ambient temperature is defined as follows:

$$I_{RMS}$$
 (85 °C) = Factor × I_{RMS} (70 °C) = 0.7 × 26.5 A_{RMS} = 18.55 A_{RMS} .

What confirms once again that I_{RMS} (15 A_{RMS} at 20 kHz at 85 °C) is below the max specified for such frequency and ambient temperature.

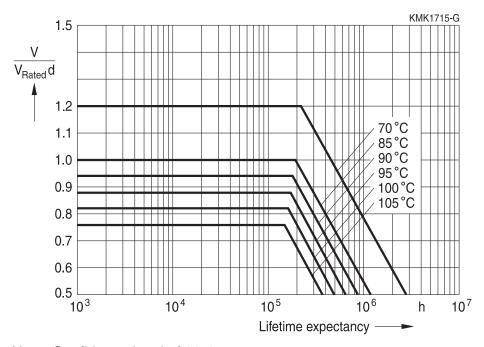




MKP DC link - high power series

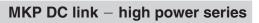
Life time expectancy - typical curve

B3267*3/4/6/1/8 (300 V DC / 450 V DC / 630 V DC / 750 V DC / 875 V DC)



Note: Confidence level of 98%







Testing and Standards

Test	Reference	Conditions of test		Performance requirements
Electrical parameters (Routine test)	IEC61071:2007	Voltage between te $1.5 V_R$, during $10 s$ Insulation resistanc $V_R < 500 V$ or $500 V$ Capacitance, C at 1 (room temperature) Dissipation factor, to (room temperature)	Within specified limits	
Robustness of termina- tions (Type test)	IEC 60068-2-21:2006	Tensile strength (te Wire diameter $0.5 < d_1 \le 0.8 \text{ mm}$ $0.8 < d_1 \le 1.25 \text{ mm}$	st Ua1) Tensile force 10 N 20 N	Capacitance and tan δ within specified limits
Resistance to soldering heat (Type test)	IEC 60068-2-20:2008, test Tb, method 1A	Solder bath temper immersion for 10 se	$ \Delta C/C_0 \le 2\%$ $ \Delta \tan \delta \le 0.002$	
Rapid change of temperature (Type test)	IEC 60384-16:2005	T_A = lower category T_B = upper category Five cycles, duratio	$\begin{split} \Delta C/C_0 &\leq 2\% \\ \Delta \tan \delta &\leq 0.002 \\ R_{ins} &\geq 50\% \text{ of initial limit} \end{split}$	
Vibration (Type test)	IEC 60384-16:2005	Test F _c : vibration si Displacement: 0.75 Accleration: 98 m/s Frequency: 10 Hz Test duration: 3 orth 2 hours each axe	No visible damage	
Bump (Type test)	IEC 60384-16:2005	Test Eb: Total 4000 390 m/s² mounted of Duration: 6 ms	No visible damage $\begin{split} \Delta C/C_0 &\leq 2\% \\ \Delta \ \text{tan } \delta &\leq 0.002 \\ R_{\text{ins}} &\geq 50\% \ \text{of initial limit} \end{split}$	
Climatic sequence (Type test)	IEC 60384-16:2005	Dry heat Tb / 16 h Damp heat cyclic, 1 +55 °C / 24 h / 95% Cold Ta / 2 h Damp heat cyclic, 5 +55 °C / 24 h / 95%	5 100% RH	No visible damage $ \Delta C/C_0 \leq 3\%$ $ \Delta\ tan\ \delta \leq 0.001$ $R_{ins} \geq 50\%\ of\ initial\ limit$





MKP DC link - high power series

Test	Reference	Conditions of test	Performance
			requirements
Damp heat,	IEC	Test Ca	No visible damage
steady state	60384-16:2005	40 °C / 93% RH / 56 days	$ \Delta C/C_0 \le 5\%$
(Type test)			$ \Delta \tan \delta \le 0.005$
,			$R_{ins} \ge 50\%$ of initial limit
Endurance	IEC61071:2007	70 °C / 1.4 V _R / 250 hours or	No visible damage
(Type test)		T_{op} / 1.4 V_{op} / 250 hours	$ \Delta C/C_0 \le 3\%$ at 1 kHz
		+ 1000 discharges at 1.4 I _R	$ \Delta \tan \delta \le 0.015$ at
		+70 °C / 1.4 V _R / 250 hours or	10 kHz
		T_{op} / 1.4 V_{op} / 250 hours	
Endurance	IEC	70 °C / 1.25 V _R / 1000 hours or	No visible damage
(Type test)	60384-16:2005	85 $^{\circ}$ C / 1.25 V_{op} / 1000 hours or	$ \Delta C/C_0 \le 5\%$ at 1 kHz
		100 °C / 1.25 V _{op} / 1000 hours	$ \Delta \tan \delta \le 0.005$
			$R_{ins} \ge 50\%$ of initial limit

Mounting guidelines

1 Soldering

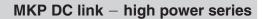
1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder



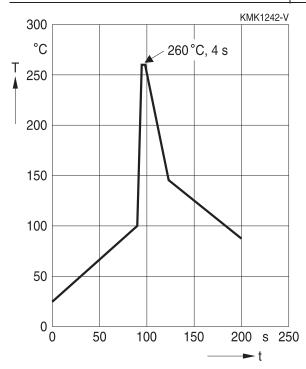




1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1. Conditions:

Series	s	Solder bath temperature	Soldering time	
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s	
MFP				
MKP	(lead spacing >7.5 mm)			
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5 ±1 s	
MKP	(lead spacing ≤7.5 mm)		<4 s	
MKT	uncoated (lead spacing ≤10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)	



Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane			
Shield	Heat-absorbing board, (1.5 ± 0.5) mm thick, between			
	capacitor body and liquid solder			
Evaluation criteria:				
Visual inspection	No visible damage			
$\Delta C/C_0$	2% for MKT/MKP/MFP			
$\Delta O/O_0$	5% for EMI suppression capacitors			
$tan \delta$	As specified in sectional specification			





MKP DC link - high power series

1.3 General notes on soldering

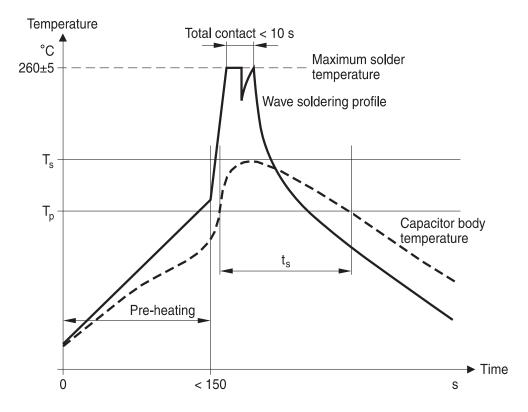
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

Recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:



T_s: Capacitor body maximum temperature at wave soldering

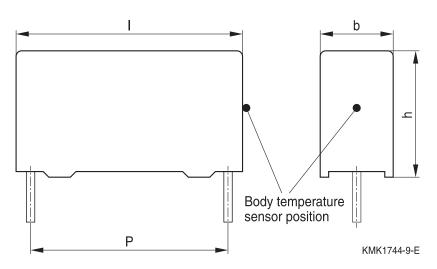
 T_p : Capacitor body maximum temperature at pre-heating

KMK1745-A-E









Body temperature should follow the description below:

MKP capacitor

During pre-heating: T_p ≤110 °C

During soldering: $T_s \le 120$ °C, $t_s \le 45$ s

MKT capacitor

During pre-heating: T_p ≤125 °C

During soldering: T_s ≤160 °C, t_s ≤45 s

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be ≤ 120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to our Film Capacitors Data Book in case more details are needed.





MKP DC link - high power series

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage	Make sure that capacitors are stored within the	4.5
conditions	specified range of time, temperature and humidity conditions.	"Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"





Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.

Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

Correlation of data sheet values and modelling tool outputs

Data sheet values and results of design tools may deviate as they have not been derived in the same context.

While data sheets show individual parameter statements without considering a possible dependency to other parameters. Tools model a complete given scenario as input and processed inside the tool.

Furthermore as we constantly strive to improve our models, the results of tools can change over time and be a non-binding indication only.





$\label{eq:mkp} \textbf{MKP DC link} - \textbf{high power series}$

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_{C}	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
β_{C}	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
ΔC/C	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation	Kapazitätstoleranz (relative Abweichung
	from rated capacitance)	vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔΤ	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F_D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
Ic	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)





MKP DC link – high power series

Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i _z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_{0}	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R_i	Internal resistance	Innenwiderstand
R _{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_s	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
tan $\delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ_{P}	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan $\delta_{ extsf{S}}$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T_A	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T_{max}	Upper category temperature	Obere Kategorietemperatur
T _{min}	Lower category temperature	Untere Kategorietemperatur
t _{OL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
T _{op}	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T _R	Rated temperature	Nenntemperatur
T _{ref}	Reference temperature	Referenztemperatur
t _{SL}	Reference service life	Referenz-Lebensdauer





MKP DC link - high power series

Symbol	English	German
V_{AC}	AC voltage	Wechselspannung
V_{C}	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
$V_{\sf FB}$	Fly-back capacitor voltage	Spannung (Flyback)
V_{i}	Input voltage	Eingangsspannung
V_{o}	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
Ŷ _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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Release 2020-06